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PATENT

Atty. Docket No. 408204

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) Efren M. Lacap et al. Examiner Jonathan J. Johnson

Serial No. 10/648,586 Group Art No. 1725

Filed 26 August 2003 Confirmation No. 4089

For WAFER-LEVEL CHIP SCALE

**PACKAGE** 

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## AMENDMENT AND RESPONSE

Sir:

These remarks respond to the Office Action of 4 January 2006. This amendment accompanies a Request for Continued Examination under 37 C.F.R. §1.114. Please amend the above-identified application as indicated herein:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.